

**PATENT ASSIGNMENT**

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Kouichi ADACHI	02/03/2010
Shunji HYODOU	02/05/2010
Yasuhiro KONISHI	02/08/2010
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<b>City:</b>	Osaka
<b>State/Country:</b>	JAPAN
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	12733307
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<b>NAME OF SUBMITTER:</b>	Donna King

OP \$40.00 12733307

Total Attachments: 3  
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**PATENT  
 REEL: 024077 FRAME: 0957**



# ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

Insert Name(s) of Inventor(s) Kouichi Adachi, of c/o Sekisui Chemical Co., Ltd., 3535, Kurohama, Hasuda-shi, Saitama Japan, Shunji Hyoudou, of c/o Sekisui Chemical Co., Ltd., 2-1, Hyakuyama, Shimamoto-cho, Mishima-gun, Osaka Japan and Yasuhiro Konishi, of c/o Sekisui Chemical Co., Ltd., 2-9, Shinsakaemachi, Naka-ku, Nagoya-shi, Aichi Japan.

the undersigned hereby sell(s) and assign(s) to

Insert Name(s) of Assignee(s) Sekisui Chemical Co., Ltd., a Japanese company of 4-4, Nishitemma 2-chome, Kita-ku, Osaka-shi, Osaka Japan

Address (hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as

Title of Invention SEALING MATERIAL

for which an application for patent in the United States has been executed by the undersigned

on \_\_\_\_\_

Date of Signing of Application The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 1030 15th Street, N.W., Suite 400 East, Washington, D.C. 20005-1503, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date	<u>Feb. 3, 2010</u>	, Name of the Inventor	<u>Adachi Kouichi</u>
Date	<u>Feb. 5, 2010</u>	, Name of the Inventor	<u>Hyoudou Shunji</u>
Date	<u>Feb. 8, 2010</u>	, Name of the Inventor	<u>Konishi Yasuhiro</u>
Date	_____	, Name of the Inventor	_____
Date	_____	, Name of the Inventor	_____
Date	_____	, Name of the Inventor	_____
Date	_____	, Name of the Inventor	_____

(This assignment should preferably be acknowledged before a United States Consul. If not, then the execution by the Inventor(s) should be witnessed by at least two witnesses who sign here.)

Witness Yoichiro Komori, Feb. 2010.

Witness Niroaki Hamano, Feb 2010

### ACKNOWLEDGMENT

\_\_\_\_\_  
\_\_\_\_\_ } ss

This \_\_\_\_\_ day  
of \_\_\_\_\_, 19\_\_\_\_\_, before me personally came the

above-named me personally known as the individual(s) who executed the foregoing assignment, who did acknowledge to me that he (they) executed the same of his (their) own free will for the purposes therein set forth.

SEAL

\_\_\_\_\_  
Official Signature

\_\_\_\_\_  
Official Title

The above application may be more particularly identified as follows:

U.S. Application Serial No. \_\_\_\_\_ Filing Date \_\_\_\_\_

Applicant Reference Number \_\_\_\_\_ Atty Docket No. \_\_\_\_\_

Title of Invention \_\_\_\_\_

\_\_\_\_\_